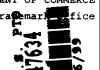
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: SHEET

U.S. DEPARTMENT OF COMMERCE

Patent and Trapemari



OMB No. 0651-0011 (exp. 4/94) Taksettings ⇒ ⇒ ⇒ ▼

FORM PTO-1595

(Rev. 6-93)

To the Assistant Commissioner for Patents: Please record the attached original documents or copy thereof. 2. Name and address of receiving party(iest Name of conveying party(ies): Takashi SUGINO Name: LINTEC CORPORATION Hideo SENOO Yasukazu NAKATA Internal Address: __ Additional name(s) of conveying party(ies) attached?

Yes No Street Address: 23-23, Honcho, Itabashi-ku, 3. Nature of conveyance: Tokyo 173-0001, Japan ■ Assignment □ Merger City: ___ □ Security Agreement □ Change of Name State: _____ ZIP: □ Other __ Additional name(s) & address(es) attached?

Yes
No Execution Date: June 14, 1999 09347634 4. Application number(s) or patent number(s): If this document is being filed together with a new application,

June 14, 1999 A. Patent Application No.(s) B. Patent No.(s) Additional numbers attached?

Yes
No 5. Name and address of party to whom correspondence 6. Total number of applications and |1| concerning document should be mailed: patents involved: Russell D. Orkin Internal Address: Webb Ziesenheim Logsdon 7. Total fee (37 CFR 3.41)........\$ 40.00 Orkin & Hanson, P.C. ☑ Enclosed Street Address: 700 Koppers Building □ Authorized to be charged to deposit account 436 Seventh Avenue 8. Deposit account number: City: Pittsburgh State: PA ZIP: 15219-1818 (Attach triplicate copy of this page if paying by deposit account) DO NOT USE THIS SPACE 9. Statement and signature. To the best of my knowledge and belief, the foregoing information is true and correct and any attached copy is a true copy of the original document, July 6, 1999 Kent E. Baldauf Name of Person Signing Req. No. 25,826 4 Total number of pages including cover sheet, attachments and document

> Mail documents to be recorded with required cover sheet information to: Assistant Commissioner for Patents, Box Assignments Washington, D.C. 20231

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Assignment

WHEREAS, We, ___ See the attached sheet, please.

| and | | residing |
|-------------------------|--|------------|
| in | See the attached sheet, please. | and |
| | | ectively, |
| have | ADHESIVE COMPOSITION AND ADHESIVE SHEET | |
| | which we have this day executed an application for es Letters Patent; | or United |
| | AND, WHEREAS LINTEC CORPORATION | _ , a |
| corp | oration of Japan J | , having a |
| place here: entir | e of business at 23-23, Honcho, Itabashi-ku, Tokyo 1 inafter called the "assignee", is desirous of acquire right, title, and interest in and to said applications and improvements therein disclosed. | iring the |

NOW, THEREFORE, in consideration of One (\$1.00) Dollar and other good and valuable consideration paid to us by said assignee, the receipt of which is hereby acknowledged, we do hereby assign, sell, transfer, and set over unto said assignee the entire right, title and interest in and to said application and the inventions and improvements therein disclosed for the United States and all foreign countries and any Letters Patent which may issue therefor in the United States and all foreign countries and all divisions, reissues, continuations, renewals, and/or extensions thereof, said assignee to have and to hold the interests herein assigned to the full ends of the terms of said Letters Patent and any and all divisions, reissues, continuations, renewals, and/or extensions thereof, respectively, as fully and entirely as the same would have been held and enjoyed by us had this assignment not been made.

The Commissioner of Patents and Trademarks is requested to issue such Letters Patent in accordance herewith. We covenant that we are the lawful owners of the said application, inventions, and improvements, that the same are unencumbered, that no license has been granted to make, use, or vend the said inventions or improvements or any of them, and that we have the full right to make this assignment.

And for the consideration aforesaid, we agree jointly and individually that we will communicate to said assignee or the representatives thereof any facts known to us respecting said inventions and improvements, and will, upon request, but without expense to us, testify in any legal proceedings, sign all lawful papers, execute all divisional, reissue, continuation, renewal, and/or extension applications, make all rightful oaths, and generally do all other and further lawful acts, deemed necessary or expedient by said assignee or by counsel for said assignee, to assist or enable said assignee to obtain and enforce full benefits from the rights and interests herein assigned. This assignment shall be binding upon our heirs, executors,

PATENT REEL: 010089 FRAME: 0028 administrators, and/or assigns, and shall inure to the benefit of the heirs, executors, administrators, successors, and/or assigns, as the case may be, of said assignee.

| EXECUTED | June 14, | , 19 99 . |
|--------------------------------|----------|--------------------------|
| | Takashi | Sugino Takashi SUGINO |
| | 1/-/ | Takashi SUGINO |
| | HIDEO | Senon Hideo SENOO |
| Tashihisu Shibasaki | yasupazu | Chahata |
| Vashuhisu Shutasaku Witness | - | Yasukazu NAKATA |
| | | • |

- 2 -

ASSIGNMENT

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PATENT REEL: 010089 FRAME: 0030

RECORDED: 07/06/1999